

Product Data Sheet Type: PR17/25/SE

Group: HEATSINKS Board Level

For single mounting

Width :	17 mm
Height :	13 mm
Length :	25 mm
Minimum thermal resistance :	24 K/W
For device :	TO 220
Device mounted by :	Screw
Heatsink mounted by :	Srew-On
Surface :	Black Anodised
Material :	AlMgSi0,5



- U-extruded especially for semiconductor case TO220 or 2xSOT32(TO126).
- Standard type, ready to be fitted:
 - PR 17/15/SE = with 3 mm hole for lying mounting
 - PR 17/25/SE = with M3-thread for lying mounting
 - PR 17/35/SE = with M3-thread for lying mounting
 - PR 17/35II/SE = with 3,0 mm holes for lying mounting and twist protection
 - PR 17/50/SE = with 3,0 mm holes for double mounting SOT32(TO126)
- Also available in meter lengths.
- Other lengths and machining on request.

